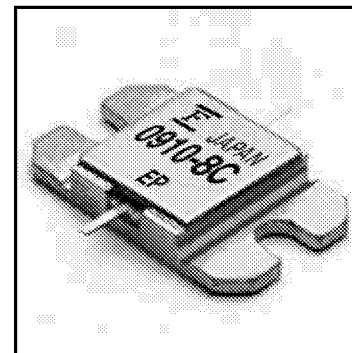


FEATURES

- High Output Power: $P_{1dB} = 38.5\text{dBm}$ (Typ.)
- High Gain: $G_{1dB} = 6.0\text{dB}$ (Typ.)
- High PAE: $\eta_{add} = 24\%$ (Typ.)
- Broad Band: 9.5 ~ 10.5GHz
- Impedance Matched $Z_{in}/Z_{out} = 50\Omega$
- Hermetically Sealed



DESCRIPTION

The FLM0910-8C is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

Fujitsu's stringent Quality Assurance Program assures the highest reliability and consistent performance.

ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ\text{C}$)

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	V_{DS}		15	V
Gate-Source Voltage	V_{GS}		-5	V
Total Power Dissipation	P_T	$T_C = 25^\circ\text{C}$	42.8	W
Storage Temperature	T_{stg}		-65 to +175	$^\circ\text{C}$
Channel Temperature	T_{ch}		175	$^\circ\text{C}$

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 16.0 and -4.4 mA respectively with gate resistance of 100 Ω .

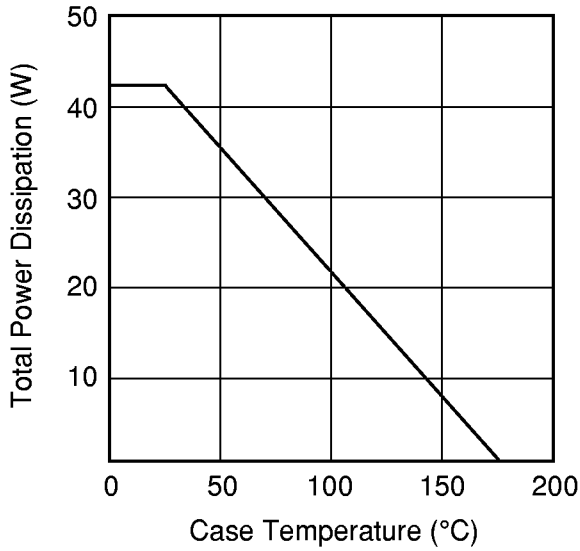
ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ\text{C}$)

Item	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Saturated Drain Current	I_{DSS}	$V_{DS} = 5\text{V}, V_{GS} = 0\text{V}$	-	3600	5400	mA
Transconductance	g_m	$V_{DS} = 5\text{V}, I_{DS} = 2200\text{mA}$	-	2000	-	mS
Pinch-off Voltage	V_p	$V_{DS} = 5\text{V}, I_{DS} = 180\text{mA}$	-1.0	-2.0	-3.5	V
Gate Source Breakdown Voltage	V_{GSO}	$I_{GS} = -180\mu\text{A}$	-5	-	-	V
Output Power at 1dB G.C.P.	P_{1dB}	$V_{DS} = 10\text{V},$ $I_{DS} = 0.6 I_{DSS}$ (Typ.), $f = 9.5 \sim 10.5\text{GHz},$ $Z_S = Z_L = 50\text{ohm}$	37.5	38.5	-	dBm
Power Gain at 1dB G.C.P.	G_{1dB}		5.0	6.0	-	dB
Drain Current	I_{dsr}		-	2200	2600	mA
Power-added Efficiency	η_{add}		-	24	-	%
Thermal Resistance	R_{th}	Channel to Case	-	3.0	3.5	$^\circ\text{C}/\text{W}$

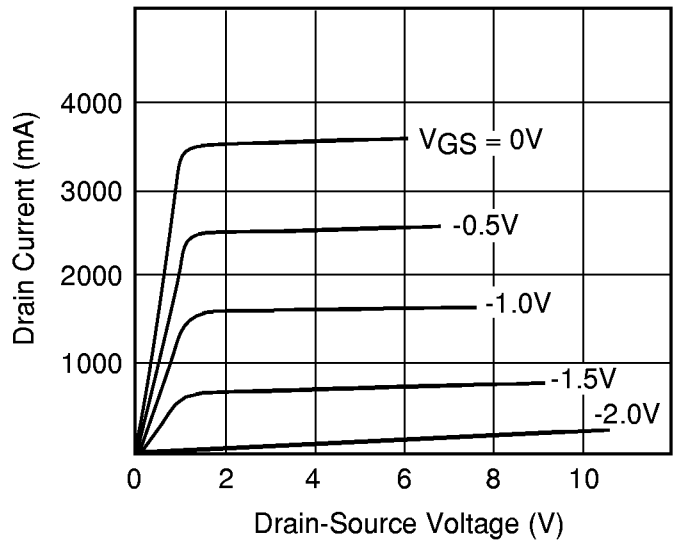
CASE STYLE: IB

G.C.P.: Gain Compression Point

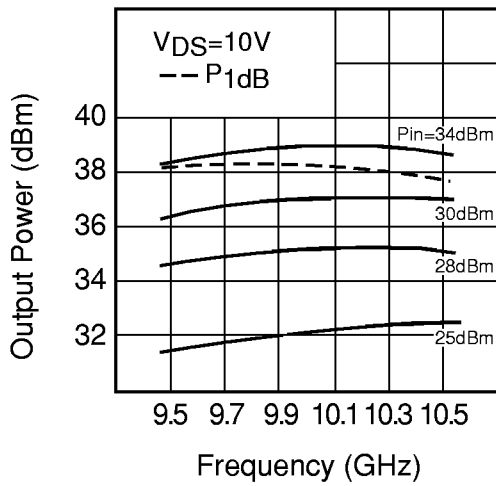
POWER DERATING CURVE



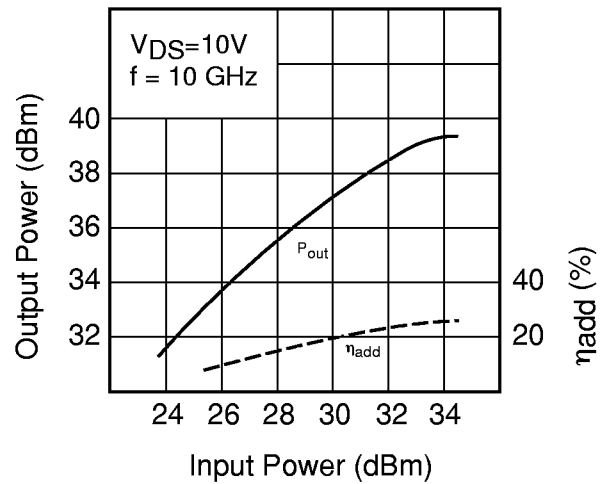
DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE

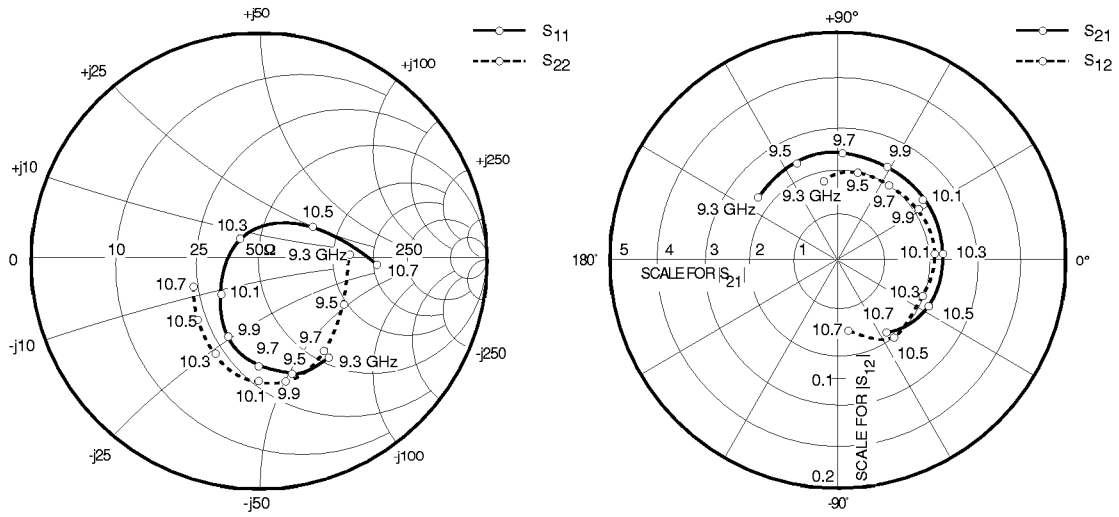


OUTPUT POWER vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER





S-PARAMETERS

$V_{DS} = 10V, I_{DS} = 2200mA$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
9300	.53	-52	2.32	138	.07	100	.42	2
9500	.52	-73	2.37	114	.08	78	.44	-26
9700	.47	-94	2.39	89	.08	56	.48	-52
9900	.39	-116	2.37	63	.08	33	.52	-75
10100	.26	-143	2.37	36	.09	7	.52	-95
10300	.10	131	2.35	6	.08	-23	.48	-118
10500	.30	30	2.17	-27	.08	-55	.41	-140
10700	.52	-4	1.79	-58	.06	-84	.35	-158

Case Style "IB"
Metal-Ceramic Hermetic Package

